

AMP-HDI

TE Internal #: 5532436-1

PCB Mount Header, Vertical, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

Signal, Black
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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 100

Number of Rows: 4

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Vertical
Number of Positions	100
Number of Rows	4
Electrical Characteristics	
Insulation Resistance	4 MΩ

Black

Body Features

Primary Product Color



Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	.1 μm[3.937 μin]
Contact Layout	Matrix
Contact Shape & Form	Four Beam
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
	29.9212 μin
Contact Type	Pin
Contact Current Rating (Max)	

Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.83 mm[.19 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic

Dimensions

Connector Height	11.73 mm[.461 in]	
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Usage Conditions

Housing Temperature Rating	High
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]

Operation/Application

Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0



Packaging Features

Packaging Quantity	7
Packaging Type	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts









Customers Also Bought







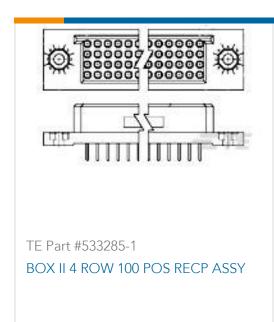












Documents

Product Drawings

ASSY,PIN,VERTICAL,HDI,LEAD-FRE

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5532436-1_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5532436-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5532436-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

PCB Mount Header, Vertical, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



English